



ORDER INFORMATION:

CFS1.27-	X	X	X	X
<u>Header Type:</u>				
0:Type IA	9:Type IAR	Stand Off:	0:0mm	Contact Plating:
1:Type IAR	A:Type IIB,BO	1:1.64mm	2:2.20mm	1:Gold Flush
2:Type IB	B:Type IIBR	3:1.70mm	4:15u" Gold Sel.	0:White W/O Nut
3:Type IBR	C:Type IE			1:White W/ Nuts
4:Type IC	D:Type IF			
5:Type ICR	E:Type IGO			
6:Type ID	F:Type IGOR			
7:Type IDR	G:Type IIBDRS			
8:Type IIA				

更改 REV	設 變 內 容 MODIFICATION	日 期 DATE	修 改 DRAW

NOTES:
 1.MATERIAL:
 INSULATOR:GLASS REINFORCED LCP UL94V-0
 CONTACT:BRASS ALLOY
 MOUNT EAR:BRASS; TIN PLATED OVERALL
 2.CONTACT PLATING:
 CONTACT AREA:GOLD PLATING OVER 40u" NICKEL
 SOLDER TAIL AREA:100u" TIN PLATING OVER 40u" NICKEL

DIMENSION IN mm [Inch]		 康茂股份有限公司 COMMA ELECTRONIC INC	
TOLERANCE UNLESS OTHERWISE SPECIFIED		名稱 TITLE	CUSTOMER DRAWING
.X±0.3	X:± 3'	CF Card Header SMT 50P Type I (GO)	
.XX±0.20	.X'± 0.5'	案 號 FILE NO. 60144320	圖 號 DWG NO. CFS1.27-E320
.XXX±0.100	.XX'± 0.25'	圖紙 SIZE A4	角法 PROJ. 第一角 比例 SCALE N.S.T.
		日期 DATE 05/08/03	更改 REV A